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Quad single-pole single-throw analog switch

Rev. 8 — 11 September 2014

**Product data sheet** 

### 1. General description

The HEF4066B provides four single-pole, single-throw analog switch functions. Each switch has two input/output terminals (nY and nZ) and an active HIGH enable input (nE). When nE is LOW, the analog switch is turned off.

The HEF4066B is pin compatible with the HEF4016B but exhibits a much lower ON resistance. In addition the ON resistance is relatively constant over the full input signal range.

### 2. Features and benefits

- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Inputs and outputs are protected against electrostatic effects
- Specified from -40 °C to +85 °C and -40 °C to +125 °C
- Complies with JEDEC standard JESD 13-B

# 3. Applications

- Analog multiplexing and demultiplexing
- Digital multiplexing and demultiplexing
- Signal gating

# 4. Ordering information

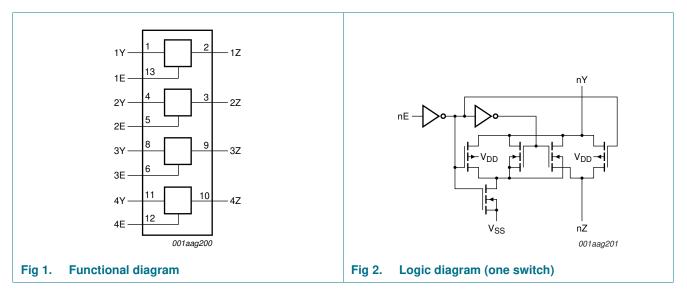
#### Table 1.Ordering information

Type number Package							
	Temperature range	Name	Description	Version			
HEF4066BP	–40 °C to +125 °C	DIP14	plastic dual in-line package; 14 leads (300 mil)	SOT27-1			
HEF4066BT	–40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1			



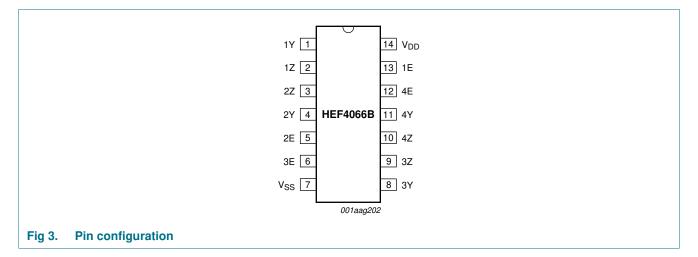
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# 5. Functional diagram



# 6. Pinning information

### 6.1 Pinning



# 6.2 Pin description

Table 2. Pin description	on		
Symbol	Pin	Description	
1Y, 2Y, 3Y, 4Y	1, 4, 8, 11	independent input or output	
1Z, 2Z, 3Z, 4Z	2, 3, 9, 10	independent input or output	
1E, 2E, 3E, 4E	13, 5, 6, 12	enable input (active HIGH)	
V <sub>SS</sub>	7	ground (0 V)	
V <sub>DD</sub>	14	supply voltage	

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# 7. Functional description

Table 3.   Function table <sup>[1]</sup>	
Input nE	Switch
Н	ON
L	OFF

[1] H = HIGH voltage level; L = LOW voltage level.

### 8. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to  $V_{SS} = 0 V$  (ground).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>DD</sub>	supply voltage			-0.5	+18	V
I <sub>IK</sub>	input clamping current	$V_{\rm I} < -0.5$ V or $V_{\rm I} > V_{\rm DD}$ + 0.5 V		-	±10	mA
VI	input voltage			-0.5	V <sub>DD</sub> + 0.5	V
I <sub>I/O</sub>	input/output current		[1]	-	±10	mA
T <sub>stg</sub>	storage temperature			-65	+150	°C
T <sub>amb</sub>	ambient temperature			-40	+85	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \text{ °C to } +85 \text{ °C}$				
		DIP14	[2]	-	750	mW
		SO14	[3]	-	500	mW
Р	power dissipation	per switch		-	100	mW

[1] To avoid drawing V<sub>DD</sub> current out of terminal nZ, when switch current flows into terminals nY, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal nZ, no V<sub>DD</sub> current will flow out of terminals nY, in this case there is no limit for the voltage drop across the switch, but the voltages at nY and nZ may not exceed V<sub>DD</sub> or V<sub>SS</sub>.

[2] For DIP14 packages: above  $T_{amb}$  = 70 °C, P<sub>tot</sub> derates linearly with 12 mW/K.

[3] For SO14 packages: above  $T_{amb} = 70 \text{ °C}$ ,  $P_{tot}$  derates linearly with 8 mW/K.

# 9. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>DD</sub>	supply voltage		3	-	15	V
VI	input voltage		0	-	V <sub>DD</sub>	V
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall	$V_{DD} = 5 V$	-	-	3.75	μs/V
rate	rate	V <sub>DD</sub> = 10 V	-	-	0.5	μs/V
		V <sub>DD</sub> = 15 V	-	-	0.08	μs/V

#### Table 5. Recommended operating conditions

#### Quad single-pole single-throw analog switch

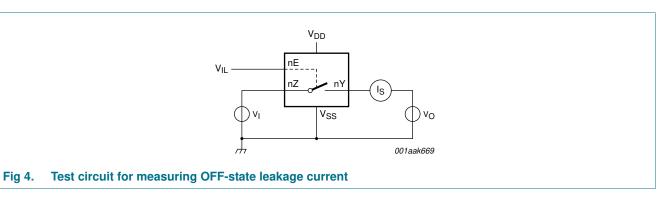
# **10. Static characteristics**

#### Table 6. Static characteristics

 $V_{SS} = 0$  V;  $V_{I} = V_{SS}$  or  $V_{DD}$  unless otherwise specified.

Symbol	Parameter	Conditions	$V_{DD}$	T <sub>amb</sub> =	<b>−40 °C</b>	T <sub>amb</sub> =	: 25 °C	T <sub>amb</sub> =	: 85 °C	T <sub>amb</sub> =	125 °C	Unit
				Min	Max	Min	Max	Min	Max	Min	Max	
V <sub>IH</sub>	HIGH-level	I <sub>O</sub>   < 1 μA	5 V	3.5	-	3.5	-	3.5	-	3.5	-	V
	input voltage		10 V	7.0	-	7.0	-	7.0	-	7.0	-	V
			15 V	11.0	-	11.0	-	11.0	-	11.0	-	V
V <sub>IL</sub>	LOW-level	I <sub>O</sub>   < 1 μA	5 V	-	1.5	-	1.5	-	1.5	-	1.5	V
	input voltage		10 V	-	3.0	-	3.0	-	3.0	-	3.0	V
			15 V	-	4.0	-	4.0	-	4.0	-	4.0	V
l <sub>l</sub>	input leakage current		15 V	-	±0.1	-	±0.1	-	±1.0	-	±1.0	μA
I <sub>S(OFF)</sub>	OFF-state leakage current	per channel; see <u>Figure 4</u>	15 V	-	-	-	200	-	-	-	-	nA
I <sub>DD</sub>	supply current		5 V	-	1.0	-	1.0	-	7.5	-	7.5	μA
		combinations	10 V	-	2.0	-	2.0	-	15.0	-	15.0	μA
			15 V	-	4.0	-	4.0	-	30.0	-	30.0	μA
Cı	input capacitance	nE input	-	-	-	-	7.5	-	-	-	-	pF

### 10.1 Test circuit



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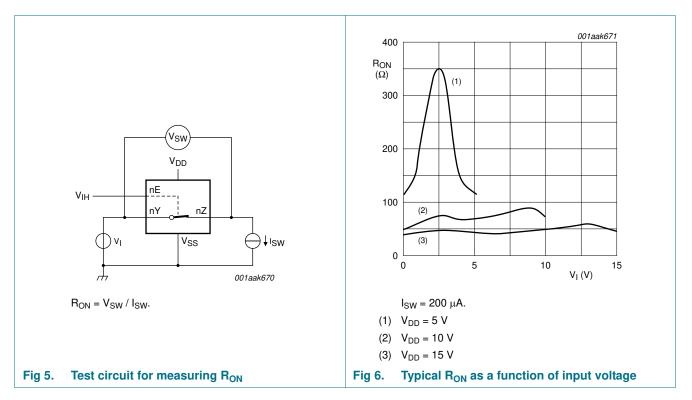
#### 10.2 ON resistance

#### Table 7. ON resistance

 $T_{amb}=25~^{\circ}C;\,I_{SW}=200~\mu A;\,V_{SS}=0~V.$ 

Symbol	Parameter	Conditions	V <sub>DD</sub>	Тур	Max	Unit
R <sub>ON(peak)</sub>	ON resistance (peak)	$V_I = 0$ V to $V_{DD}$ ; see Figure 5 and	5 V	350	2500	Ω
		Figure 6	10 V	80	245	Ω
			15 V	60	175	Ω
R <sub>ON(rail)</sub> ON resistance (rail)		$V_I = 0 V$ ; see Figure 5 and Figure 6	5 V	115	340	Ω
			10 V	50	160	Ω
			15 V	40	115	Ω
		$V_{I} = V_{DD}$ ; see <u>Figure 5</u> and <u>Figure 6</u>	5 V	120	365	Ω
			10 V	65	200	Ω
			15 V	50	155	Ω
$\Delta R_{ON}$	ON resistance mismatch	$V_I = 0 V$ to $V_{DD}$ ; see Figure 5	5 V	25	-	Ω
b	between channels		10 V	10	-	Ω
			15 V	5	-	Ω

#### 10.2.1 ON resistance waveform and test circuit



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# **11. Dynamic characteristics**

#### Table 8. Dynamic characteristics

 $T_{amb} = 25 \ ^{\circ}C; V_{SS} = 0 V;$  for test circuit see <u>Figure 9</u>.

Symbol	Parameter	Conditions	V <sub>DD</sub>	Тур	Max	Unit
t <sub>PHL</sub>	HIGH to LOW propagation delay	nY, nZ to nZ, nY; see <u>Figure 7</u>	5 V	10	20	ns
			10 V	5	10	ns
			15 V	5	10	ns
		nY, nZ to nZ, nY; see Figure 7	5 V	10	20	ns
			10 V	5	10	ns
			15 V	5	10	ns
t <sub>PHZ</sub>	HIGH to OFF-state		5 V	80	160	ns
	propagation delay		10 V	65	130	ns
			15 V	60	120	ns
t <sub>PZH</sub>	OFF-state to HIGH	nE to nY, nZ; see <u>Figure 8</u>	5 V	40	80	ns
	propagation delay		10 V	20	40	ns
			15 V	15	30	ns
t <sub>PLZ</sub>	LOW to OFF-state	nE to nY, nZ; see Figure 8	5 V	80	160	ns
	propagation delay		10 V	70	140	ns
			15 V	70	140	ns
t <sub>PZL</sub>	OFF-state to LOW	nE to nY, nZ; see Figure 8	5 V	45	90	ns
	propagation delay		10 V	20	40	ns
			15 V	15	30	ns

#### Table 9. Dynamic power dissipation P<sub>D</sub>

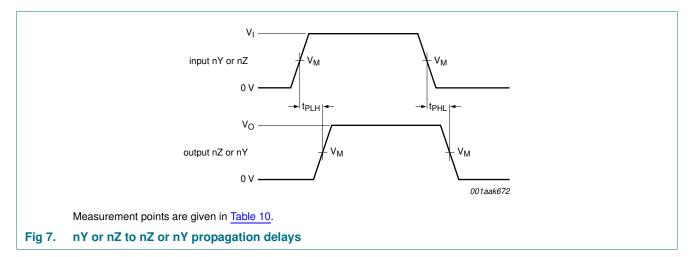
 $P_D$  can be calculated from the formulas shown;  $V_{SS} = 0$  V;  $t_r = t_f \le 20$  ns;  $T_{amb} = 25$  °C.

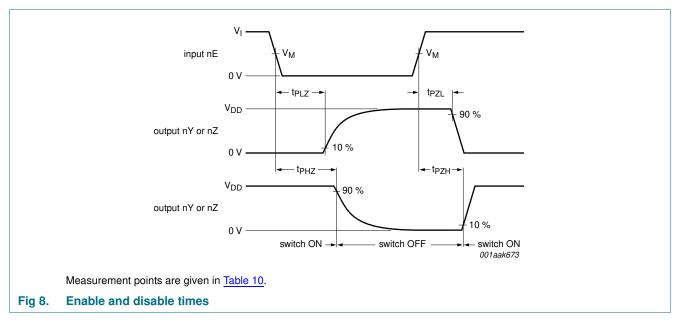
Symbol	Parameter	V <sub>DD</sub>	Typical formula for $P_D$ ( $\mu$ W)	where:
P <sub>D</sub>	dynamic power	5 V	$P_{D} = 2500 \times f_{i} + \Sigma (f_{o} \times C_{L}) \times V_{DD}^{2}$	f <sub>i</sub> = input frequency in MHz;
	dissipation	10 V	$P_{D} = 11500 \times f_{i} + \Sigma (f_{o} \times C_{L}) \times V_{DD}^{2}$	f <sub>o</sub> = output frequency in MHz;
		15 V	$P_{D} = 29000 \times f_{i} + \Sigma (f_{o} \times C_{L}) \times V_{DD}^{2}$	C <sub>L</sub> = output load capacitance in pF;
				$V_{DD}$ = supply voltage in V;
				$\Sigma(C_L \times f_o) = sum of the outputs.$

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#### Quad single-pole single-throw analog switch

### 11.1 Waveforms and test circuit





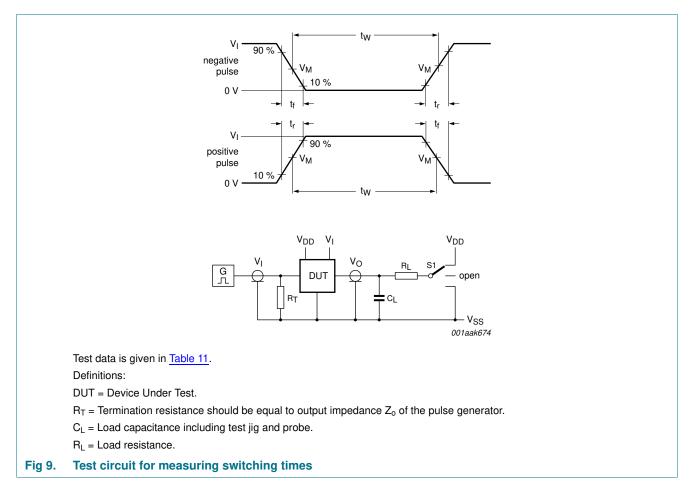
#### Table 10.Measurement points

Supply voltage	Input	Output
V <sub>DD</sub>	V <sub>M</sub>	V <sub>M</sub>
5 V to 15 V	0.5V <sub>DD</sub>	0.5V <sub>DD</sub>

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#### Table 11. Test data

Supply voltage	Input		Load		S1 position		
V <sub>DD</sub>	VI	t <sub>r</sub> , t <sub>f</sub>	CL	RL	t <sub>PHL</sub> , t <sub>PLH</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>
5 V to 15 V	0 V or $V_{DD}$	≤ 20 ns	50 pF	10 kΩ	V <sub>SS</sub>	V <sub>SS</sub>	V <sub>DD</sub>

### 11.2 Additional dynamic parameters

#### Table 12. Additional dynamic characteristics

 $V_{SS} = 0 V; T_{amb} = 25$ °C.

Symbol	Parameter	Conditions	V <sub>DD</sub>		Тур	Max	Unit
THD	total harmonic distortion	see Figure 10; $R_L = 10 \text{ k}\Omega$ ; $C_L = 15 \text{ pF}$ ;	5 V	<u>[1]</u>	0.25	-	%
		channel ON; $V_I = 0.5V_{DD}$ (p-p); f <sub>i</sub> = 1 kHz	10 V	<u>[1]</u>	0.04	-	%
		$i_i = 1$ KHZ	15 V	<u>[1]</u>	0.04	-	%
V <sub>ct</sub>	crosstalk voltage	nE input to switch; see Figure 11; $R_L = 10 \text{ k}\Omega$ ; $C_L = 15 \text{ pF}$ ; $nE = V_{DD}$ (square-wave)	10 V		50	-	mV

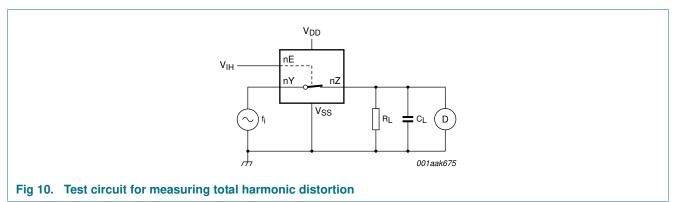
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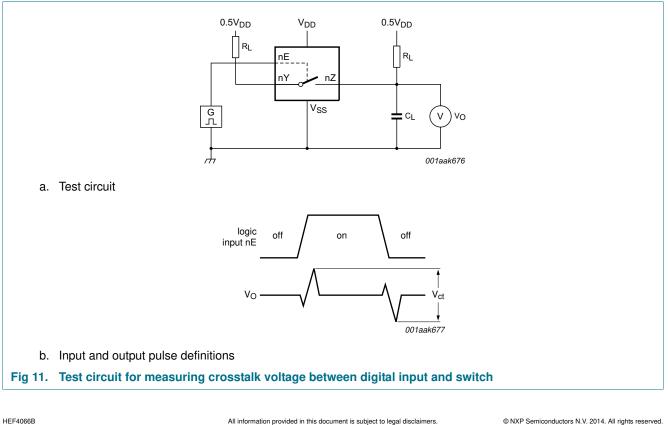
#### Table 12. Additional dynamic characteristics ...continued

$V_{SS} = 0 V; T_{amb} = 25 \circ C.$							
Symbol	Parameter	Conditions	V <sub>DD</sub>		Тур	Max	Unit
Xtalk	crosstalk	between switches; see Figure 12; $f_i = 1 \text{ MHz}; R_L = 1 \text{ k}\Omega;$ $V_I = 0.5V_{DD} \text{ (p-p)}$	10 V	[1]	-50	-	dB
$\alpha_{iso}$	isolation (OFF-state)	see Figure 13; $f_i = 1 \text{ MHz}$ ; $R_L = 1 \text{ k}\Omega$ ; $C_L = 5 \text{ pF}$ ; $V_I = 0.5V_{DD}$ (p-p)	10 V	[1]	-50	-	dB
f <sub>(-3dB)</sub>	-3 dB frequency response	see Figure 14; $R_L = 1 \text{ k}\Omega$ ; $C_L = 5 \text{ pF}$ ; $V_I = 0.5V_{DD} \text{ (p-p)}$	10 V	[1]	90	-	MHz

[1]  $f_i$  is biased at 0.5V<sub>DD</sub>.

### 11.2.1 Test circuits

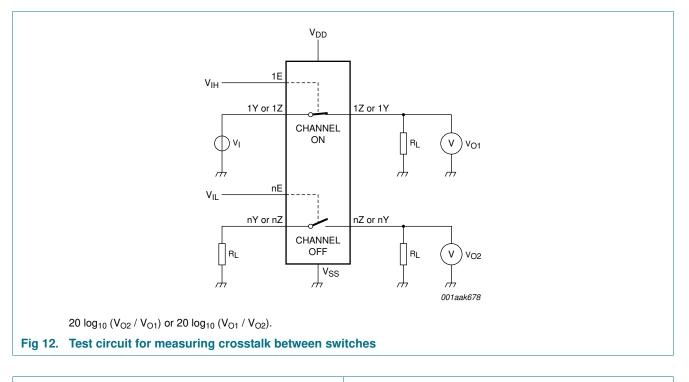


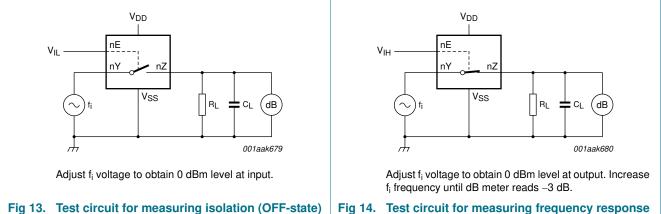


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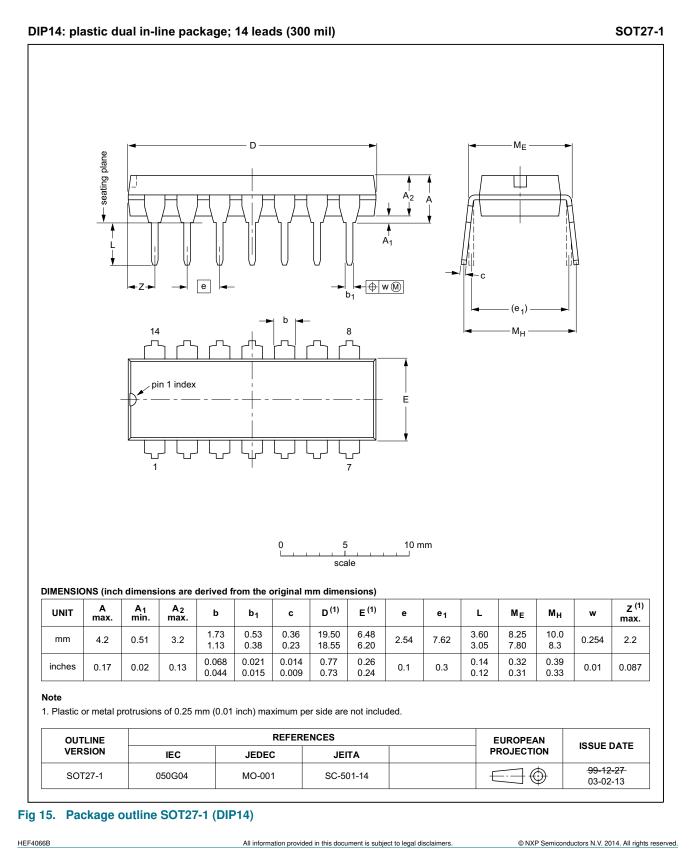




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Quad single-pole single-throw analog switch

## 12. Package outline



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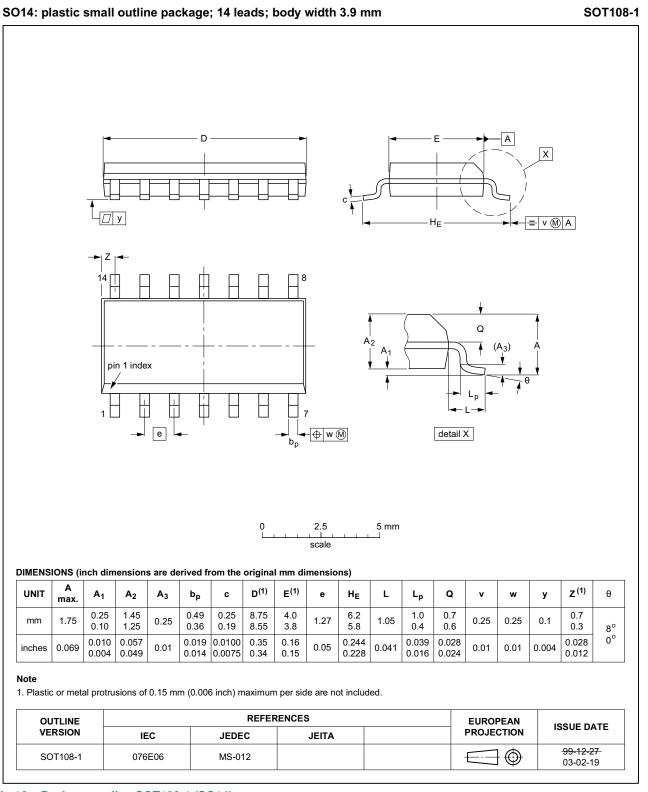


Fig 16. Package outline SOT108-1 (SO14)

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# **13. Abbreviations**

Table 13. Abbreviati	ons
Acronym	Description
DUT	Device Under Test

# 14. Revision history

#### Table 14.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
HEF4066B v.8	20140911	Product data sheet	-	HEF4066B v.7	
Modifications:	• Figure 11: Tes	st circuit modified	-		
HEF4066B v.7	20111116	Product data sheet	-	HEF4066B v.6	
Modifications:	Legal pages updated.				
	<ul> <li>Changes in "C</li> </ul>	General description", "Features	and benefits" and "	Applications".	
HEF4066B v.6	20100325	Product data sheet	-	HEF4066B v.5	
HEF4066B v.5	20100225	Product data sheet	-	HEF4066B v.4	
HEF4066B v.4	20091013	Product data sheet	-	HEF4066B_CNV v.3	
HEF4066B_CNV v.3	19950101	Product specification	-	HEF4066B_CNV v.2	
HEF4066B_CNV v.2	19950101	Product specification	-	-	

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